

### **Features**

Collector Current: I<sub>C</sub>=-1A

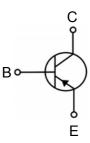
• Power Dissipation of 1.5w



SOT-223 (SOT-223-3)

# **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
BCP53-16,115	SOT-223 (SOT-223-3)	BCP53	1000



# Maximum Ratings (Ta=25°C unless otherwise noted)

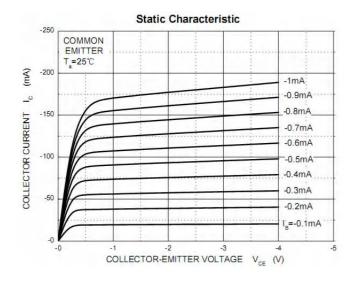
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-100	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-80	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V
Collector Current	I <sub>C</sub>	-1	А
Collector Power Dissipation	P <sub>c</sub>	1.5	W
Thermal Resistance From Junction To Ambient	$R_{\ThetaJA}$	94	°C/W
Junction Temperature	T <sub>j</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55∼+150	℃

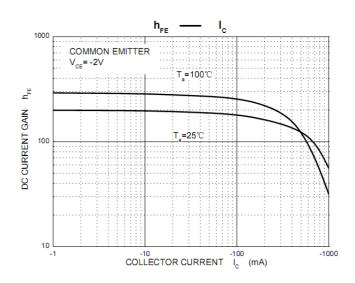


## Electrical Characteristics Ta=25°C unless otherwise specified

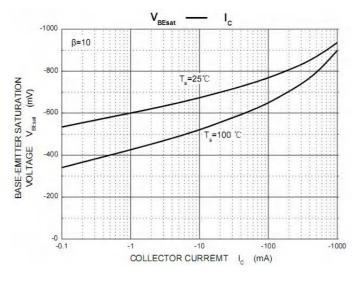
Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =- 0.1mA,I <sub>E</sub> =0	-100		V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = -10mA,I <sub>B</sub> =0	-80		V
Base-emitter breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = -10μA,I <sub>C</sub> = 0	-5		V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -30 V, I <sub>E</sub> =0		-100	nA
	h <sub>FE(1)</sub>	V <sub>CE</sub> =-2V, I <sub>C</sub> =-5mA	25		
DC current gain	h <sub>FE(2)</sub>	V <sub>CE</sub> = -2V, I <sub>C</sub> =-150m A	100	250	
	h <sub>FE(3)</sub>	V <sub>CE</sub> = -2V, I <sub>C</sub> =-500m A	25		
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =-500mA,I <sub>B</sub> = -50mA		-0.5	V
Base-emitter voltage	$V_{BE}$	V <sub>CE</sub> =-2V, I <sub>C</sub> =-500m A		-1	V
Transition frequency	f⊤	V <sub>CE</sub> =-10V,I <sub>C</sub> =-50mA,f=100MHz	100		MHz

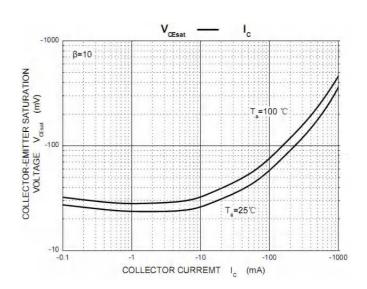
# **Typical Characteristics**

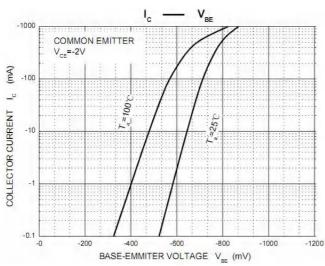


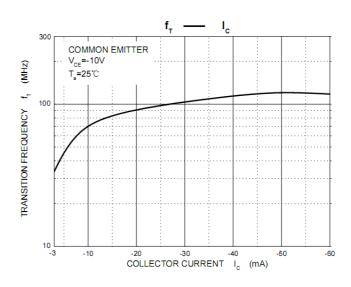


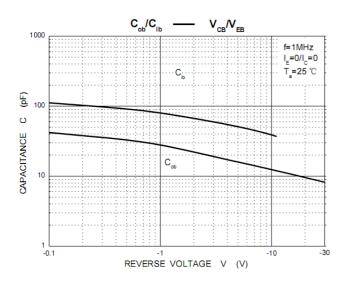


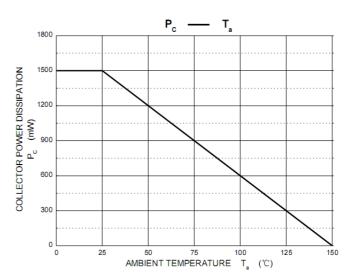






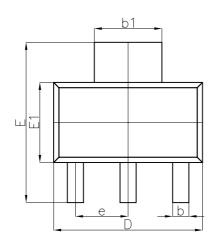


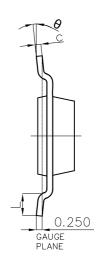


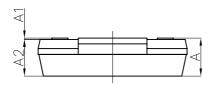




# SOT-223(SOT-223-3) Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α		1.800		0.071	
A1	0.020	0.100	0.001	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.840	0.026	0.033	
b1	2.900	3.100	0.114	0.122	
С	0.230	0.350	0.009	0.014	
D	6.300	6.700	0.248	0.264	
E	6.700	7.300	0.264	0.287	
E1	3.300	3.700	0.130	0.146	
е	2.300(BSC)		0.091(BSC)		
L	0.750		0.030		
θ	0°	10°	0°	10°	



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